

# **DATA SHEET**

CURRENT SENSOR - LOW TCR
AUTOMOTIVE GRADE
PE\_L series
5%, 1%, 0.5%, 0.1%
sizes
0201/0402/ 0603/ 0805/ 1206/ 2010/ 2512

RoHS compliant & Halogen free



YAGEO Phicomp



# <u>SCOPE</u>

This specification describes PE series current sensor - low TCR with lead-free terminations made by metal film with ceramic substrate.

#### <u>APPLICATIONS</u>

- · Consumer goods
- Computer
- Telecom / Datacom
- Industrial / Power supply
- Automotive
- Alternative Energy

#### **FEATURES**

- · AEC-Q200 qualified
- · Halogen-free Epoxy
- RoHS compliant
- · Reduce environmentally hazardous wastes
- · High component and equipment reliability
- · None forbidden-materials used in products/production
- · Low resistances applied to current sensing

#### ORDERING INFORMATION - GLOBAL PART NUMBER

Global part numbers are identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

#### **GLOBAL PART NUMBER**

PE XXXX X X X XX XXXX L (1) (2) (3) (4) (5) (7)

(I) SIZE

0201/0402/0603/0805/1206/2010/2512

#### (2) TOLERANCE

B =  $\pm 0.1\%$  (only for 0805,  $> 50 \text{m}\Omega$ )

 $D = \pm 0.5\% (\geq 10 \text{m}\Omega)$ 

 $F = \pm 1\%$ 

 $| = \pm 5\%$ 

#### (3) PACKAGING TYPE

R = Paper/ PE taping reel

K = Embossed taping reel

# (4) TEMPERATURE COEFFICIENT OF RESISTANCE

 $E = \pm 50 \text{ ppm/°C}$ 

 $M = \pm 75 \text{ ppm/°C}$ 

 $F = \pm 100 \text{ ppm/°C}$ 

 $J = \pm 350 \text{ ppm/°C}$ 

## (5) TAPING REEL

07 / 7W / 7T / 47 / 57= 7 inch dia. Reel and specific rated power.

Detailed power rating are shown in the Table 2.

# (6) RESISTANCE VALUE

 $5 \text{ m}\Omega$  to  $910 \text{ m}\Omega$ 

There are 3~5 digits indicated the resistance value. Letter R is decimal point.

Detailed coding rules of resistance are shown in the table of "Resistance rule of global part number".

# (7) DEFAULT CODE

Letter L is the system default code for ordering only. (Note)

Resistance rule of global part number

Resistance code rule	Example
	0R001 = 1 mΩ
0RXXX	$0RI = 100  \text{m}\Omega$
$(1 \text{ to } 910 \text{ m}\Omega)$	$0R91 = 910 \text{ m}\Omega$

# ORDERING EXAMPLE

The ordering code of a PE2512 IW chip resistor, value 0.1  $\Omega$  with ±1% tolerance, supplied in 7-inch tape reel is: PE2512FKM070R1L

#### NOTE

I. All our RSMD products are RoHS compliant. "LFP" of the internal 2D reel label mentions "Lead-Free Process"

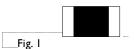
PE\_L

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## MARKING

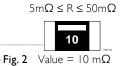
# PE0201 / PE0402



No marking

#### .....ı ığ.

#### PE0603

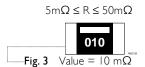






2 digits

## PE0805

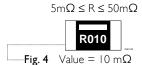






3 digits

#### PE1206



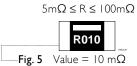




4 digits

The "R" is used as a decimal point; the other 3 digits are significant.

# PE2010 / PE2512



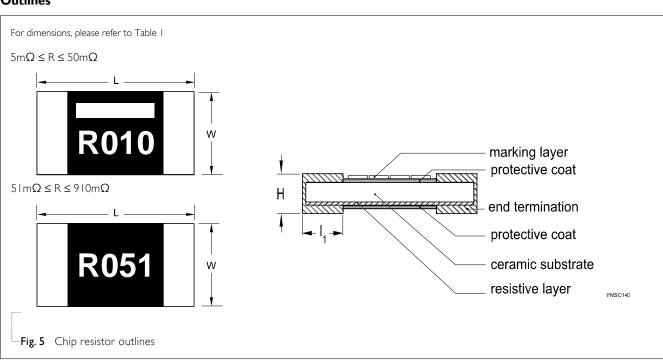




4 digits

The "R" is used as a decimal point; the other 3 digits are significant.

# Outlines





 Chip Resistor Surface Mount
 PE\_L
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# <u>DIMENSION</u>

Table I For outlines, please refer to Fig. 4

TYPE	RESISTANCE RANGE	L (mm)	W (mm)	H (mm)	I <sub>I</sub> (mm)
PE0201	50 mΩ ≤ R ≤ 200 mΩ	0.60±0.03	0.31±0.04	0.27±0.04	0.14±0.06
PE0402	$10 \text{ m}\Omega \leq R \leq 910 \text{ m}\Omega$	1.00+0.10/-0.15	0.50+0.10/-0.15	0.35±0.15	0.25±0.10
PE0603	$5 \text{ m}\Omega \leq R \leq 50 \text{ m}\Omega$	1.60±0.20	0.76±0.25	0.35±0.25	0.38±0.25
1 20003	$51 \text{ m}\Omega \leq R \leq 910 \text{ m}\Omega$	1.52±0.25	0.76±0.25	0.45±0.10	0.38±0.25
PE0805	$5 \text{ m}\Omega \leq R \leq 50 \text{ m}\Omega$	2.03±0.25	1.27±0.25	0.35±0.25	0.38±0.25
1 20003	$51 \text{ m}\Omega \leq R \leq 910 \text{ m}\Omega$	2.03±0.25	1.27±0.25	0.55±0.10	0.35±0.20
PE1206	5 mΩ	3.20±0.25	1.60±0.25	0.64±0.25	0.64±0.25
1 L1 200	$6 \text{ m}\Omega \leq R \leq 910 \text{ m}\Omega$	3.20±0.25	1.60±0.25	0.64±0.25	0.5 l ±0.25
PE2010	$5 \text{ m}\Omega \leq R \leq 6 \text{ m}\Omega$	5.08±0.25	2.54±0.25	0.64±0.25	1.47±0.25
PEZUIU	$7 \text{ m}\Omega \leq R \leq 910 \text{ m}\Omega$	5.08±0.25	2.54±0.25	0.64±0.25	0.5 l ±0.25
PE2512	$6 \text{ m}\Omega \leq R \leq 910 \text{ m}\Omega$	6.35±0.25	3.18±0.25	0.64±0.25	0.76±0.25

#### Note

<sup>1.</sup> For relevant physical dimensions, please refer to construction outlines.

<sup>2.</sup> Please contact with sales offices, distributors and representatives in your region before ordering.

# **ELECTRICAL CHARACTERISTICS**

Table 2

CEDIE	POWER RATING (1)		TOLEDANICE	RESISTANCE	TEMPERATURE COEFFICIENT					
SEKIE	:22IZE	07	7W	7T	47	57	TOLERANCE	RANGE	OF RESISTANCE	
	0201	1/20W	1/10W					$50 \text{ m}\Omega \leq R \leq 200 \text{m}\Omega$	$50 \text{m}\Omega \le R \le 70 \text{m}\Omega \pm 350 \text{ppm/°C}$ $70 \text{m}\Omega < R \le 200 \text{m}\Omega \pm 100 \text{ppm/°C}$	
	0402	1/16W	1/8W	1/6W	1/4W			$10\mathrm{m}\Omega \le \mathrm{R} \le 910\mathrm{m}\Omega$	±100 ppm/°C	
	0603	1/10W	1/5W	1/3W	2/5W	1/2W	$\pm 0.1\%$ (only for $0805, >50 \text{m}\Omega$ ) $\pm 0.5\% (\geq 10 \text{m}\Omega)$	` '	5 O ( D ( O O O	±75 ppm/°C
PE	0805	1/8W	1/4W	1/3W	1/2W			$5 \mathrm{m}\Omega \le R \le 910 \mathrm{m}\Omega$	±100 ppm/°C	
	1206	1/4) 4/	1./2\/		13.4.6		±1%	$5m\Omega \le R \le 19m\Omega$	±75ppm/°C, ±100ppm/°C	
	1206	1/4W	1/2W		IW		±5%	$20m\Omega \le R \le 910m\Omega$	±50ppm/°C, ±75ppm/°C, ±100ppm/°C	
	2010	1/2W	IW				<del>-</del>	$5m\Omega \le R \le 910m\Omega$	±50 ppm/°C ±75 ppm/°C	
	2512	IW	2W				-	$6m\Omega \le R \le 910m\Omega$	±100 ppm/°C	

Note: I. Global part number (code 10 - 11)

2. Please contact with sales offices, distributors and representatives in your region before ordering.

# FUNCTIONAL DESCRIPTION

## **OPERATING TEMPERATURE RANGE**

PE0201 to PE0402 Range: -55°C to +125°C (Fig. 6-1) PE0603 to PE2512 Range: -55°C to +170°C (Fig. 6-2)

## **POWER RATING**

Standard rated power at 70°C:

PE0201 = 1/20W

PE0402 = 1/16W

PE0603 = 1/10W

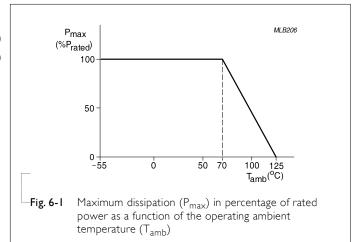
PE0805 = 1/8W

PE1206 = 1/4W

PE2010 = 1/2W

PE2512 = IW

For detail power value, please refer to Table 2.



# **RATED VOLTAGE**

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

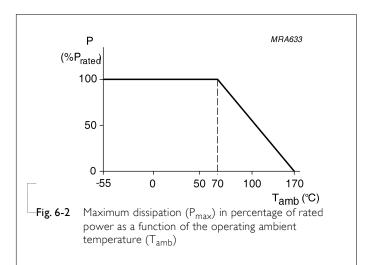
$$V = \sqrt{(PxR)}$$

Where

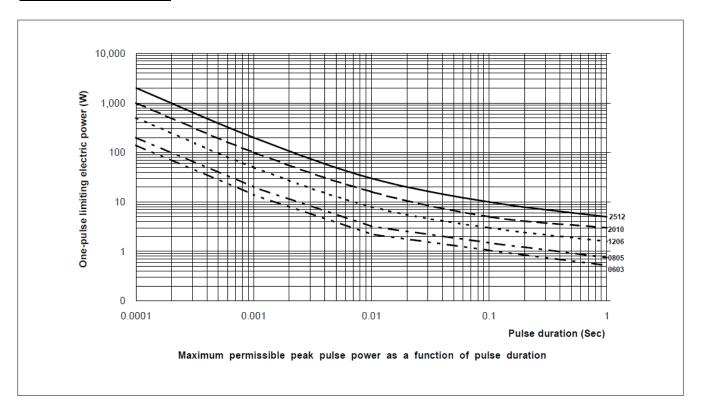
V = Continuous rated DC or AC (rms) working voltage (V)

P = Rated power (W)

 $R = Resistance value (\Omega)$ 



# PULSE LOAD BEHAVIOR

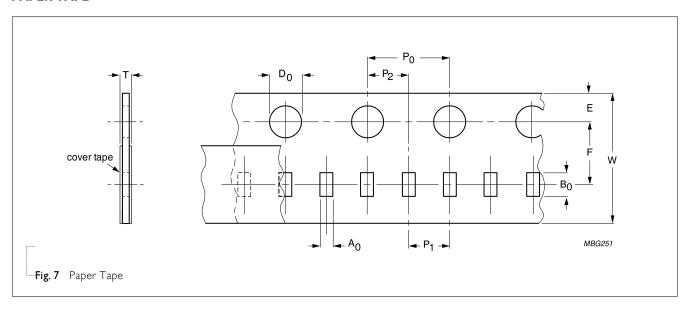


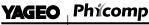
# PACKING STYLE AND PACKAGING QUANTITY

Table 3 Packing style and packaging quantity

PACKING STYLE	REEL DIMENSION	PE0201	PE0402	PE0603	PE0805	PE1206	PE2010	PE2512
Paper taping reel (R)	7" (178 mm)	10,000	10,000	5,000	5,000	4,000		
Embossed taping reel (K)	7" (178 mm)						4,000	4,000

## **PAPER TAPE**



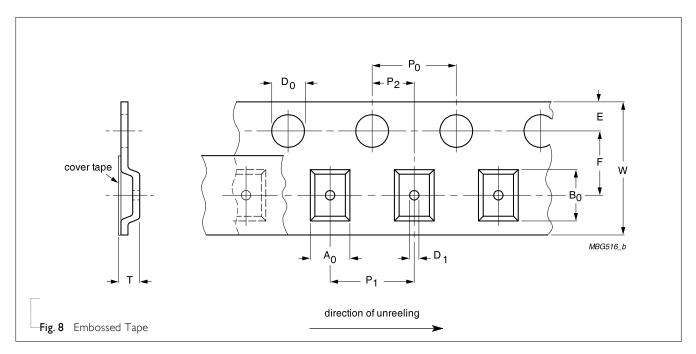


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Table 4 Dimensions of paper tape for relevant chip resistors size

CIZE	SYMBOL									Unit: mm
SIZE	A <sub>0</sub>	B <sub>0</sub>	W	E	F	P <sub>0</sub>	Pı	P <sub>2</sub>	ØD₀	Т
PE0201	0.35±0.10	1.65±0.10	8.00±0.30	1.75±0.10	3.50±0.10	4.00±0.10	2.00±0.05	2.00±0.05	1.50±0.10	0.53±0.10
PE0402	0.65±0.10	1.15±0.10	8.00±0.30	1.75±0.10	3.50±0.10	4.00±0.10	2.00±0.05	2.00±0.05	1.50±0.10	0.53±0.10
PE0603	1.20±0.15	1.90±0.15	8.00±0.30	1.75±0.10	3.50±0.10	4.00±0.10	4.00±0.10	2.00±0.10	1.50±0.10	0.55±0.15
PE0805	1.60±0.15	2.30±0.15	8.00±0.30	1.75±0.10	3.50±0.10	4.00±0.10	4.00±0.10	2.00±0.10	1.50±0.10	0.85±0.15
PE1206	1.90±0.10	3.50±0.10	8.00±0.30	1.75±0.10	3.50±0.10	4.00±0.10	4.00±0.10	2.00±0.10	1.50±0.10	1.50±0.10

## **EMBOSSED TAPE**

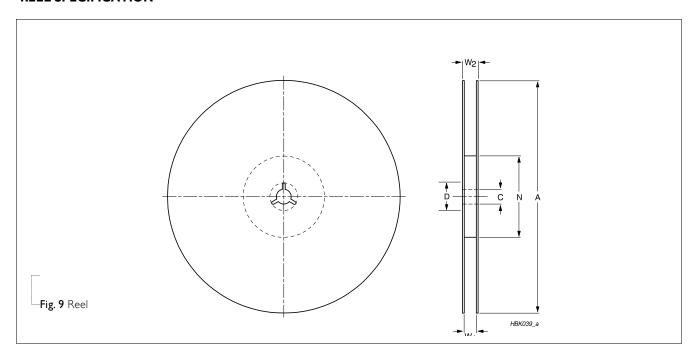


\_\_\_Table 5 Dimensions of embossed tape for relevant chip resistors size

SIZE	SYMBOL										Unit: mm
	$A_0$	B <sub>0</sub>	W	E	F	$P_0$	Pı	$P_2$	$ \emptyset D_0 $	$\emptyset D_1$	Т
PE2010	3.00±0.15	5.60±0.15	12.10±0.30	1.75±0.10	5.50±0.10	4.00±0.10	4.00±0.10	2.00±0.10	1.50±0.10	1.50±0.10	0.80±0.15
PE2512	3.40±0.15	6.70±0.15	12.10±0.30	1.75±0.10	5.50±0.10	4.00±0.10	4.00±0.10	2.00±0.10	1.50±0.10	1.50±0.10	0.80±0.15



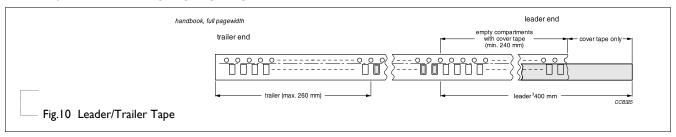
# **REEL SPECIFICATION**



**Table 6** Dimensions of reel specification for relevant chip resistors size

	QUANTITY -		REEL SIZE		SYMBOL					Unit: mm
SIZE	PER REEL	8 mm TAPE WIDE	I2 mm TAPE WIDE	24 mm TAPE WIDE	Α	Ν	С	D	Wı	W <sub>2 MAX.</sub>
PE0201	10,000	7" (Ø178 mm)			180.0+0/-3	60.0+1/-0	13.0±0.2	21.0±0.8	9.0±0.30	12.4
PE0402	10,000	7" (Ø178 mm)			180.0+0/-3	60.0+1/-0	13.0±0.2	21.0±0.8	9.0±0.30	12.4
PE0603	5000	7" (Ø178 mm)			180.0+0/-3	60.0+1/-0	13.0±0.2	21.0±0.8	8.4 +1/-0	12.4
PE0805	5000	7" (Ø178 mm)			180.0+0/-3	60.0+1/-0	13.0±0.2	21.0±0.8	8.4 +1/-0	12.4
PE1206	4000	7" (Ø178 mm)			180.0+0/-3	60.0+1/-0	13.0±0.2	21.0±0.8	8.4 +1/-0	12.4
PE2010	4000		7" (Ø178 mm)		180.0+0/-3	60.0+1/-0	13.0±0.2	21.0±0.8	12.3 +1/-0	18.4
PE2512	4000		7" (Ø178 mm)		180,0+0/-3	60.0+1/-0	13.0±0.2	21.0±0.8	12.3 +1/-0	18.4

## LEADER/TRAILER TAPE SPECIFICATION





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# FOOTPRINT AND SOLDERING PROFILES

For recommended soldering profiles, please refer to data sheet "Chip resistors mounting".

# **FOOTPRINT**

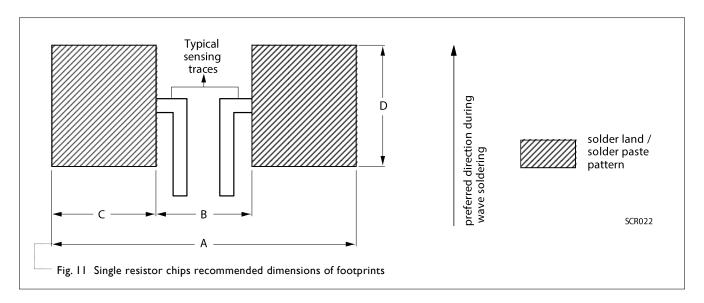


Table 7 Footprint dimensions

SIZE	RESISTANCE RANGE				Unit: mm
31ZE	RESISTAINCE RAINGE	Α	В	С	D
PE0201	$50 \text{ m}\Omega \le R \le 200 \text{ m}\Omega$	1.00	0.30	0.35	0.40
PE0402	$10 \text{ m}\Omega \le R \le 910 \text{ m}\Omega$	1.45	0.35	0.55	0.55
PE0603	$5 \text{ m}\Omega \le R \le 910 \text{ m}\Omega$	2.52	0.50	1.01	1.01
PE0805	$5 \text{ m}\Omega \le R \le 910 \text{ m}\Omega$	2.54	0.50	1.02	1.27
PE1206	$5 \text{ m}\Omega \leq R \leq 910 \text{ m}\Omega$	3.90	0.76	1.57	1.78
PE2010	$5 \text{ m}\Omega \leq R \leq 6 \text{ m}\Omega$	6.12	1.40	2.36	3.05
	$7 \text{ m}\Omega \leq R \leq 910 \text{ m}\Omega$	6.10	3.30	1.40	3.05
PE2512	6 mΩ	7.40	3.18	2.11	3.68
	$7 \text{ m}\Omega \le R \le 910 \text{ m}\Omega$	7.36	4.06	1.65	3.68



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**Chip Resistor Surface Mount** 

PE\_L

# SERIES 0201 /0402/ 0603/ 0805/ 1206/ 2010/ 2512

# TESTS AND REQUIREMENTS

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# Table 8 Test condition, procedure and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Life/	MIL-STD-202G-method 108	1,000 hours at 70±2 °C applied RCWV	±(1%+0.0005 Ω)
Operational Life/ Endurance	IEC 60115-1 4.25.1	1.5 hours on, 0.5 hour off, still air required	
High Temperature	MIL-STD-202G-method 108	I,000 hours at maximum operating temperature depending on specification, unpowered	±(1%+0.0005 Ω)
Exposure/ Endurance at		No direct impingement of forced air to the parts Tolerances:	
Upper Category Temperature		0201/0402 125±3 <b>°C</b>	
		0603 and above 170±3°C	
Moisture Resistance	MIL-STD-202G-method 106	Each temperature / humidity cycle is defined at 8 hours (method 106F), 3 cycles / 24 hours for 10d with 25 °C / 65 °C 95% R.H, without steps 7a & 7b, unpowered	0201: ±(5%+0.0005 Ω) Others: ±(0.5%+0.0005 Ω)
		Parts mounted on test-boards, without condensation on parts	
		Measurement at 24±2 hours after test conclusion	
Thermal Shock	MIL-STD-202G-method 107	-55/+125 °C	±(1%+0.0005 Ω)
		Note: Number of cycles required is 300. Devices mounted	
		Maximum transfer time is 20 seconds. Dwell time is 15 minutes. Air – Air	
Short Time	IEC60115-1 4.13	5 times of rated power for 5 seconds at room	±(1%+0.0005 Ω)
Overload		temperature	No visible damage
Board Flex/ Bending	IEC60115-1 4.33	Device mounted on PCB test board as described, only I board bending required	±(1%+0.0005 Ω)
bending		Bending for	No visible damage
		0201: 3mm	
		0402 and above: 2mm	
		Holding time: minimum 60 seconds	
Biased Humidity	MIL-STD-202	I,000 hours at 85°C/85%R.H. 10% of operating	0201: ±(5%+0.0005 Ω)
,	Method 103	power, no condensation on the devices, circulating air.	



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TEST METHOD	PROCEDURE	REQUIREMENTS
IPC/JEDEC	Electrical Test not required	Well tinned (≥95% covered)
J-STD-002B test B	Magnification 50X	No visible damage
	SMD conditions:	
	I <sup>st</sup> step: method B, aging 4 hours at 155 °C dry heat	
	2 <sup>nd</sup> step: leadfree solder bath at 245±3 °C	
	Dipping time: 3±0.5 seconds	
IPC/JEDEC	Leadfree solder, 260 °C,	No visible damage
J-STD-002B test D	30 seconds immersion time	
MIL-STD-202G-method 210F	Condition B, no pre-heat of samples	±(0.5%+0.0005 Ω)
IEC 60115-1 4.18	Leadfree solder, 260 °C, 10 seconds immersion time	No visible damage
	Procedure 2 for SMD: devices fluxed and cleaned with isopropanol	
	IPC/JEDEC J-STD-002B test B  IPC/JEDEC J-STD-002B test D  MIL-STD-202G-method 210F	IPC/JEDEC  J-STD-002B test B  Magnification 50X  SMD conditions:  Ist step: method B, aging 4 hours at 155 °C dry heat  2nd step: leadfree solder bath at 245±3 °C  Dipping time: 3±0.5 seconds  IPC/JEDEC  J-STD-002B test D  Leadfree solder, 260 °C, 30 seconds immersion time  MIL-STD-202G-method 210F  Condition B, no pre-heat of samples  Leadfree solder, 260 °C, 10 seconds immersion time  Procedure 2 for SMD: devices fluxed and



**Chip Resistor Surface Mount** 

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# **REVISION HISTORY**

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 7	Jan. 21, 2019	-	- Extended resistor value for PE2010 and 2512
Version 6	Oct. 22, 2018	-	- Extend resistor value for PE0603 and 0805, and 0.1% tol for $$ 0805 $> 50 m\Omega$ - Add in pulse load behavior
Version 5	Nov 23, 2016	-	- Extend resistor value for 0.5%
Version 4	Dec. 21, 2015	-	- Update resistance value
Version 3	Aug. 06, 2015	-	- Update 0603 to 1206 TCR
Version 2	Apr. 20, 2015	-	- Extend resistor value
Version I	Mar. 04, 2015	-	- Update TCR and operating temperature
Version 0	Feb. 10, 2015	-	- New datasheet for current sensor - low TCR PE series sizes of 0201/0402/0603/0805/1206/2010/2512, 0.5%, 1%, and 5%

PE\_L

SERIES

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